

**ZXTC2045E6** 

#### 30V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26

#### **Features**

- NPN + PNP Combination
- BV<sub>CEO</sub> > 30 (-30)V
- BV<sub>CEV</sub> > 40 (-40)V
- I<sub>CM</sub> = 5 (-5)A Peak Pulse Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Description**

Advanced process capability is used to achieve this high performance device. Combining NPN and PNP transistors, the SOT26 package provides a compact solution for the intended applications.

#### **Mechanical Data**

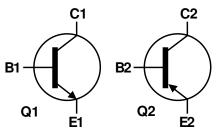
- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.015 grams (Approximate)

## **Applications**

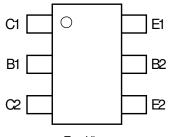
- MOSFET and IGBT Gate Driving
- Motor Drive







Device Symbol



Top View Pin-Out

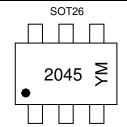
### Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC2045E6TA	AEC-Q101	2045	7	8	3,000
ZXTC2045E6QTA	Automotive	2045	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.
- 5. For packaging details, go to our website at http://www.diodes.com

### **Marking Information**



2045 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: C = 2015)

M or  $\overline{M}$  = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016		2017	2018	2019	2020	202	1 20	22 2	2023	2024	2025
Code	С		D		Е	F	G	Н		,	J	K	L	М
Monti	h	Ja	n F	eb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	,	1		2	3	4	5	6	7	8	9	0	N	D



**ZXTC2045E6** 

## Absolute Maximum Ratings - Q1 (NPN Transistor) (@TA = +25 ℃, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	40	V
Collector-Emitter Voltage	$V_{CEV}$	40	V
Collector-Emitter Voltage	$V_{\sf CEO}$	30	V
Emitter-Base Voltage	$V_{EBO}$	7	V
Continuous Collector Current	lc	1.5	Α
Peak Pulsed Collector Current	Ісм	5	Α
Base Current	Ι <sub>Β</sub>	1	А

### Absolute Maximum Ratings - Q2 (PNP Transistor) (@TA = +25 ℃, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEV</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-30	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	Ic	-1.5	Α
Peak Pulsed Collector Current	I <sub>CM</sub>	-5	Α
Base Current	lΒ	-1	Α

## Thermal Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
	(Notes 6 & 10)		0.7 5.6		
	(Notes 7 & 10)		0.9 7.2		
Power Dissipation Linear Derating Factor	(Notes 7 & 11)	P <sub>D</sub>	1.1 8.8	W mW/℃	
	(Notes 8 & 10)		1.1 8.8		
	(Notes 9 & 10)		1.7 13.6		
	(Notes 6 & 10)		179		
	(Notes 7 & 10)		139		
Thermal Resistance, Junction to Ambient	(Notes 7 & 11)	$R_{ heta JA}$	113	00.044	
	(Notes 8 & 10)	·	113	°C/W	
	(Notes 9 & 10)		73		
Thermal Resistance, Junction to Lead	(Note 12)	$R_{ heta JL}$	95.50		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	.€	

### ESD Ratings (Note 13)

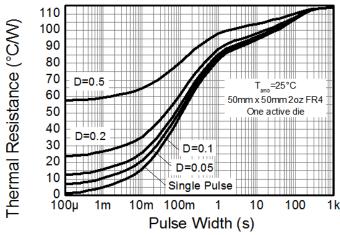
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

lotes: 6. For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

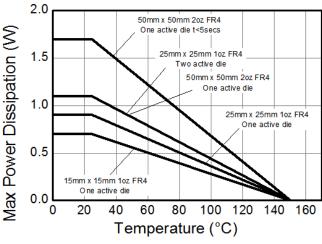
- 7. Same as Note 6, except the device is surface mounted on 25mm x 25mm 1oz copper.
- 8. Same as Note 6, except the device is surface mounted on 50mm x 50mm 2oz copper.
- 9. Same as Note 8, except the device is measured at t < 5 seconds.
- 10. For device with one active die, both collectors attached to a common heatsink.
- 11. For device with two active die running at equal power, split heatsink 50% to each collector.
- 12. Thermal resistance from junction to solder-point (at the end of the collector lead).
- 13. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



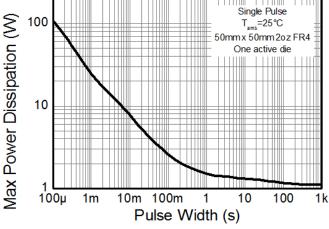
# **Thermal Characteristics and Derating Information**



Transient Thermal Impedance



**Derating Curve** 



**Pulse Power Dissipation** 



## Electrical Characteristics - Q1 (NPN Transistor) (@TA = +25 ℃, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	$BV_CBO$	40	-		V	$I_C = 100 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	BV <sub>CEV</sub>	40	-		V	$I_C = 1\mu A$ , $0.25V > V_{BE} > 1.0V$
Collector-Emitter Breakdown Voltage (Note 14)	BV <sub>CEO</sub>	30	-	_	V	$I_C = 10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.3	_	V	$I_E = 100 \mu A, I_C = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	_	<1	20	nA	$V_{CB} = 32V$
Collector Cut-Off Current	I <sub>CES/R</sub>	_	<1	20	nA	$V_{CE} = 16V, R \le 1k\Omega$
Emitter Cut-Off Current	I <sub>EBO</sub>	_	<1	20	nA	$V_{EB} = 6V$
ON CHARACTERISTICS (Note 14)						
DC Current Gain	h <sub>FE</sub>	180	300	500		$I_C = 100 \text{mA}, V_{CE} = 2V$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			375	mV	$I_C = 750 \text{mA}, I_B = 15 \text{mA}$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_		1,200	mV	$I_C = 750 \text{mA}, I_B = 15 \text{mA}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	$C_{ m obo}$		9	20	рF	$V_{CB} = 10V, f = 1.0MHz$
Current Gain-Bandwidth Product	f⊤		265		MHz	V <sub>CE</sub> = 10V, I <sub>C</sub> = 50mA, f = 100MHz
Delay Time	t <sub>d</sub>	_	10	_	ns	
Rise Time	t <sub>r</sub>	_	12		ns	$V_{CC} = 10V, I_{C} = 1A$
Storage Time	ts	_	185	_	ns	$I_{B1} = -I_{B2} = 50 \text{mA}$
Fall Time	t <sub>f</sub>	_	45	_	ns	

# Electrical Characteristics - Q2 (PNP Transistor) (@T<sub>A</sub> = +25 ℃, unless otherwise specified.)

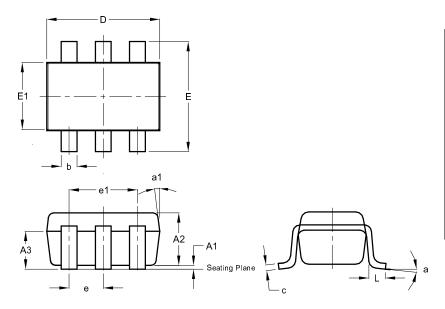
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	$BV_{CBO}$	-40	-	_	٧	$I_C = -100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	BV <sub>CEV</sub>	-40	-		٧	$I_C = -1\mu A$ , $0.25V < V_{BE} < 1.0V$
Collector-Emitter Breakdown Voltage (Note 14)	BV <sub>CEO</sub>	-30	-		٧	$I_C = -10mA, I_B = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.3	_	V	$I_E = -100 \mu A, I_C = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	_	<-1	-20	nA	V <sub>CB</sub> = -32V
Collector Cut-Off Current	I <sub>CES/R</sub>	_	<-1	-20	nA	$V_{CE} = -16V, R \le 1k\Omega$
Emitter Cut-Off Current	I <sub>EBO</sub>	_	<-1	-20	nA	V <sub>EB</sub> = -6V
ON CHARACTERISTICS (Note 14)						
DC Current Gain	h <sub>FE</sub>	180	300	500		$I_C = -100 \text{mA}, V_{CE} = -2 \text{V}$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_		-375	mV	$I_C = -750 \text{mA}, I_B = -15 \text{mA}$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_		-1,200	mV	$I_C = -750 \text{mA}, I_B = -15 \text{mA}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	$C_{obo}$	_	9	20	рF	V <sub>CB</sub> = -10V, f = 1.0MHz
Current Gain-Bandwidth Product	f <sub>T</sub>	_	195		MHz	$V_{CE} = -10V$ , $I_{C} = -50mA$ , $f = 100MHz$
Delay Time	t <sub>d</sub>	_	16		ns	
Rise Time	t <sub>r</sub>	_	11	_	ns	$V_{CC} = -10V, I_{C} = -1A$
Storage Time	ts		220	_	ns	$I_{B1} = -I_{B2} = -50 \text{mA}$
Fall Time	t <sub>f</sub>	_	31	_	ns	

Note: 14. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.



## **Package Outline Dimensions**

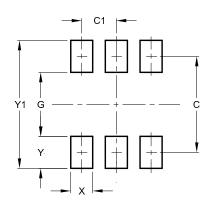
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT26						
Dim	Min	Max	Тур				
<b>A</b> 1	0.013	0.10	0.05				
A2	1.00	1.30	1.10				
А3	0.70	0.80	0.75				
b	0.35	0.50	0.38				
С	0.10	0.20	0.15				
D	2.90	3.10	3.00				
е	-	-	0.95				
e1	-	1	1.90				
Е	2.70	3.00	2.80				
E1	1.50	1.70	1.60				
L	0.35	0.55	0.40				
а	-	-	8°				
a1	-	-	7°				
All	Dimen	sions	in mm				

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20





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